



MJ N-Channel Super Trench Power MOSFET

Description

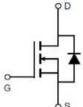
The MJXP01T10G uses Super Trench technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of R_{DS(ON)} and Qg. This device is ideal for high-frequency switching and synchronous rectification.

General Features

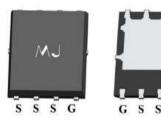
- ♦ V_{DS}=100V,I_D=105A R_{DS(ON)}=5.6mΩ (typical) @ V_{GS}=10V
- ◆ Excellent gate charge x R_{DS(on)} product(FOM)
- ♦ Very low on-resistance R_{DS(on)}
- ◆ 150°C operating temperature
- ◆ Pb-free lead plating
- ♦ 100% UIS tested

Application

- ◆ DC/DC Converter
- ◆ Ideal for high-frequency switching and synchronous rectification







Top View

Bottom View

100% UIS TESTED! 100% ΔVds TESTED!

Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity |
|----------------|------------|----------------|-----------|------------|----------|
| MJXP01T10G | MJXP01T10G | DFN5X6-8L | ä | - | 2 |

Absolute Maximum Ratings (Tc=25℃ unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|--|-----------|------------|------|
| Drain-Source Voltage | VDS | 100 | V |
| Gate-Source Voltage | Vgs | ±20 | V |
| Drain Current-Continuous | ΙD | 105 | А |
| Drain Current-Continuous(Tc =100℃) | ID(100°C) | 74 | А |
| Pulsed Drain Current | Ідм | 400 | А |
| Maximum Power Dissipation | Po | 135 | W |
| Derating factor | | 1.1 | W/°C |
| Single pulse avalanche energy (Note 5) | Eas | 676 | mJ |
| Operating Junction and Storage Temperature Range | Тл,Тѕтс | -55 To 150 | °C |

Thermal Characteristic

| Thermal Resistance, Junction-to-Case (Note 2) ReJC 0.93 | C/W |
|---|-----|
|---|-----|





Electrical Characteristics (Tc=25℃ unless otherwise noted)

| Parameter | Symbol | Condition | Min | Тур | Max | Unit |
|------------------------------------|---------------------|---|-----|----------|------|----------|
| Off Characteristics | ' | | | | | |
| Drain-Source Breakdown Voltage | BVDSS | V _{GS} =0V I _D =250µA | 100 | - | - | V |
| Zero Gate Voltage Drain Current | Ipss | V _{DS} =100V,V _{GS} =0V | - | - | 1 | μA |
| Gate-Body Leakage Current | Igss | V _{DS} =±20V,V _{DS} =0V | - | - | ±100 | nA |
| On Characteristics (Note 3) | | | 1 | | | |
| Gate Threshold Voltage | VGS(th) | V _{DS} =V _{GS} ,I _D =250µA | 2.5 | - | 4.5 | V |
| Drain-Source On-State Resistance | RDS(ON) | Vgs=10V, ID=50A | - | 5.6 | 6.4 | mΩ |
| Forward Transconductance | grs | V _{DS} =10V,I _D =50A | 40 | - | - | S |
| Dynamic Characteristics (Note 4) | | | | 1 | | |
| Input Capacitance | Clss | V _{DS} =50V,V _{GS} =0V F=1.0MHz | _ | 4300 | - | PF |
| Output Capacitance | Coss | | - | 790 | - | PF |
| Reverse Transfer Capacitance | Crss | | - | 47 | - | PF |
| Switching Characteristics (Note 4) | 1 | | | | | 1 |
| Turn-on Delay Time | t _{d(on)} | - - - - - - - - - - - - - - - - - - - | - | 13 | - | nS |
| Turn-on Rise Time | tr | | - | 58 | - | nS |
| Turn-Off Delay Time | t _{d(off)} | V _{GS} =10V,R _G =4.7Ω | - | 39 | - | nS |
| Turn-Off Fall Time | tr | _ | - | 8 | _ | nS |
| Total Gate Charge | Qg | | - | 60 | - | nC |
| Gate-Source Charge | Qgs | V _{DS} =50V,I _D =50A V _{GS} =10V | _ | 21 | - | nC |
| Gate-Drain Charge | Qgd | | _ | 11 | _ | nC |
| Drain-Source Diode Characteristics | | | | <u> </u> | | <u> </u> |
| Diode Forward Voltage (Note 3) | VsD | V _{GS} =0V,I _S =50A | _ | - | 1.2 | V |
| Diode Forward Current (Note 2) | ls | | _ | - | 105 | А |
| Reverse Recovery Time | trr | T1=25°C 1=-1= | - | 60 | - | nS |
| Reverse Recovery Charge | Qrr | TJ=25°C, IF=IS di/dt=100A/µs (Note 3) | _ | 140 | _ | nC |

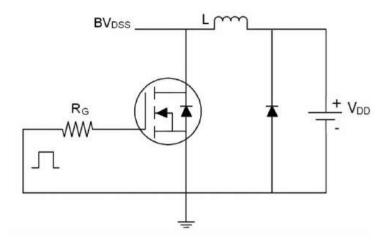
Notes:

- 1) Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4 Guaranteed by design, not subject to production
- 5 EAS condition: Tj=25°C,Vpp=50V,Vg=10V,L=0.5mH,Rg=25 Ω

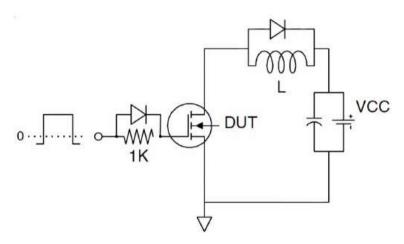




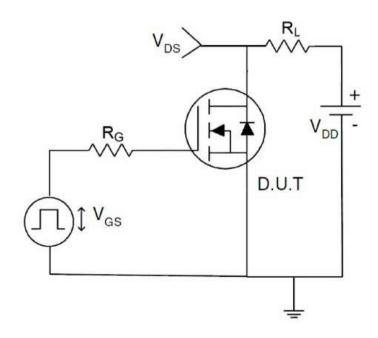
Test circuit



Eas test Circuit



Gate charge test Circuit



Switch Time Test Circuit



Typical Electrical and Thermal Characteristics (Curves)

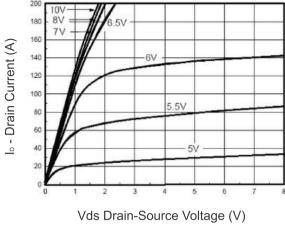


Figure 1 Output Characteristics

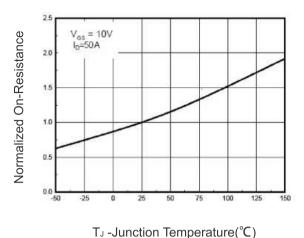


Figure 4 Rdson-Junction Temperature

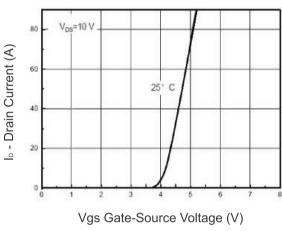


Figure 2 Transfer Characteristics

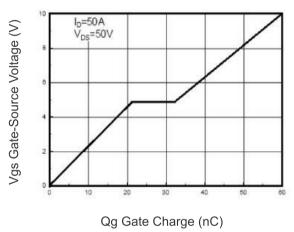


Figure 5 Gate Charge

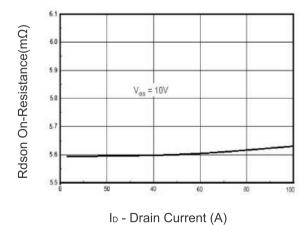


Figure 3 Rdson- Drain Current

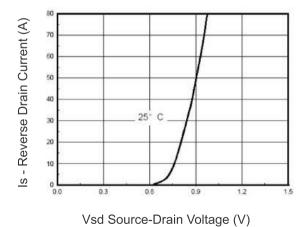


Figure 6 Source- Drain Diode Forward



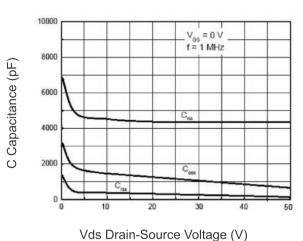
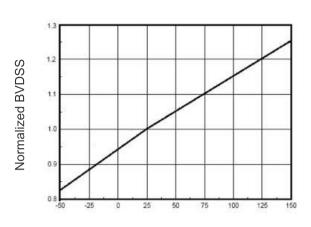


Figure 7 Capacitance vs Vds



T_J -Junction Temperature(°C)
Figure 9 BV_{DSS} vs Junction Temperature

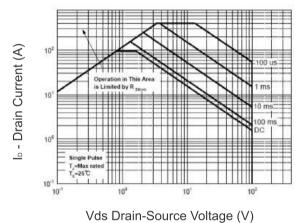
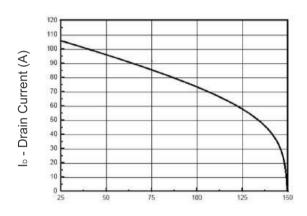
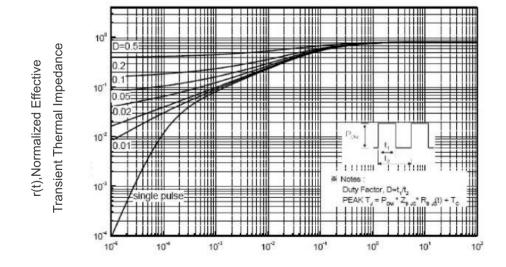


Figure 8 Safe Operation Area



T_J -Junction Temperature(°C)
Figure 10 Current De-rating



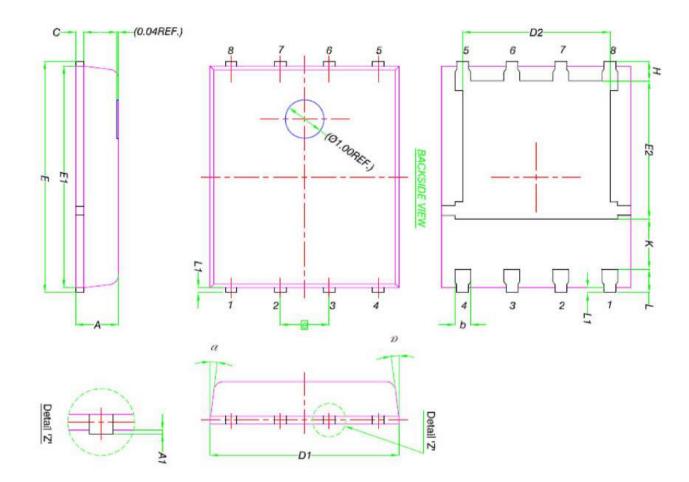
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance

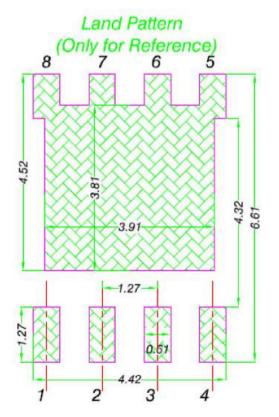




DFN5X6-8L Package Information



| DIM. | MILLIMETERS | | | |
|------|-------------|------|------|--|
| | MIN. | NOM. | MAX. | |
| Α | 0.90 | 1.00 | 1.10 | |
| A1 | 0 | | 0.05 | |
| b | 0.33 | 0.41 | 0.51 | |
| С | 0.20 | 0.25 | 0.30 | |
| D1 | 4.80 | 4.90 | 5.00 | |
| D2 | 3.61 | 3.81 | 3.96 | |
| Ε | 5.90 | 6.00 | 6.10 | |
| E1 | 5.70 | 5.75 | 5.80 | |
| E2 | 3.38 | 3.58 | 3.78 | |
| е | 1.27 BSC | | | |
| Н | 0.41 | 0.51 | 0.61 | |
| K | 1.10 | * | * | |
| L | 0.51 | 0.61 | 0.71 | |
| L1 | 0.06 | 0.13 | 0.20 | |
| α | O° | | 129 | |







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